nexperia

Final Product Change Notification

Issue Date: 30-Apr-2018 Effective Date: 29-Jul-2018

Here's your personalized quality information concerning products Digi-Key purchased from Nexperia.

For detailed information we invite you to view this notification online

201712005F01



Change Category [] Wafer Fab Process

[] Wafer Fab Materials

[] Wafer Fab Location

[] Assembly [] Product Marking [] Test [] Design Process Location [X] Assembly [] Mechanical Specification[]Test [] Errata Materials Process [] Assembly [] [] Test [] Electrical Location Packing/Shipping/Labeling Equipment spec./Test coverage

Change of lead frame version in SOT323 package

Details of this Change

Introduce R1 lead frame with optimized die pad size for SOT323 package. Change lead frame middle pad width to cater small die size (<= 0.40 mm):

Old products : Q1: 0.73mm New products: R1: 0.48mm

Why do we Implement this Change

This change will reduce the probability of sagging wire issue, for quality improvement reasons.

Identification of Affected Products

Changed products can be identified by inner lead frame design/dimensions.

Product Availability

Sample Information Samples are available upon request Latest sample request date for PCN samples is 30-May-2018. **Production**

Planned first shipment 14-Aug-2018

Impact

No impact to the products' functionality anticipated.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 30-May-2018. Lack of acknowledgement of the PCN constitutes acceptance of the change.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact Nexperia "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: **e-mail address** DiscrQA.Helpdesk.GA-Products@nexperia.com

At Nexperia B.V. we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

About Nexperia B.V.

We at Nexperia are the efficiency semiconductor company. We deliver over 70 billion products a year and as such service thousands of global customers, both directly and through our extensive network of channel partners. We are at the heart of billions of electronic devices in the Automotive, Mobile, Industrial, Consumer, Computing, and Communication Infrastructure segments.

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Affected Part Numbers							
BC847W,115	BC847CW,115	BC858W,115	BAV70W,115	BAT54C	W,115	PDTC123EU,115	
BC846AW,115	BC856AW,115	BC846W,115	BAW56W,115	BAT54S	W,115	PDTC124XU,115	
BC846BW,115	BC856BW,115	BC850BW,115	BAW56W,135	PMST22	22A,115	PDTC143TU,115	
BC846BW,135	BC856BW,135	BC848W,115	PMSS3904,115	PDTC11	4TU <i>,</i> 115	PDTC123YU,115	
BC856W,115	BC857AW,115	BC849CW,115	PMST4403,115	1PS70SI	314,115	PESD5V0L2UU,115	
BC847AW,115	BC857BW,115	BC850CW,115	PMST3904,115	BFS20W	,115	PESD6V0L2UU,115	
BC847BW,115	BC857BW,135	BAS16W,115	PMST5089,115	1PS70SI	382,115	BAS21W,115	
BC847BW,135	BC857CW,115	BC860CW,115	BAT54W,115	PDTA14	3TU,115	NUP1301U,115	